

Current status of the impedance budget for FCC-ee IR

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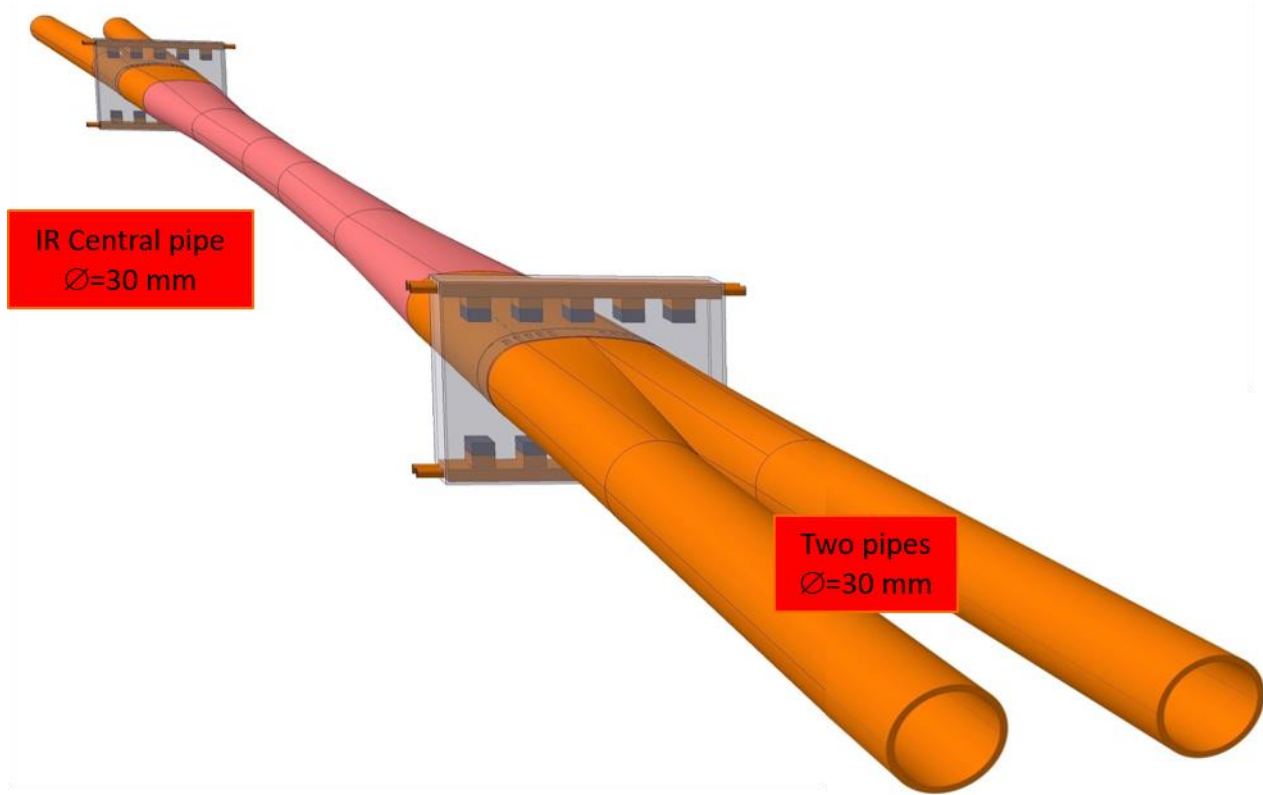
CERN and SLAC National Accelerator Laboratory

FCC-ee MDI Meeting 21
March 07, 2019

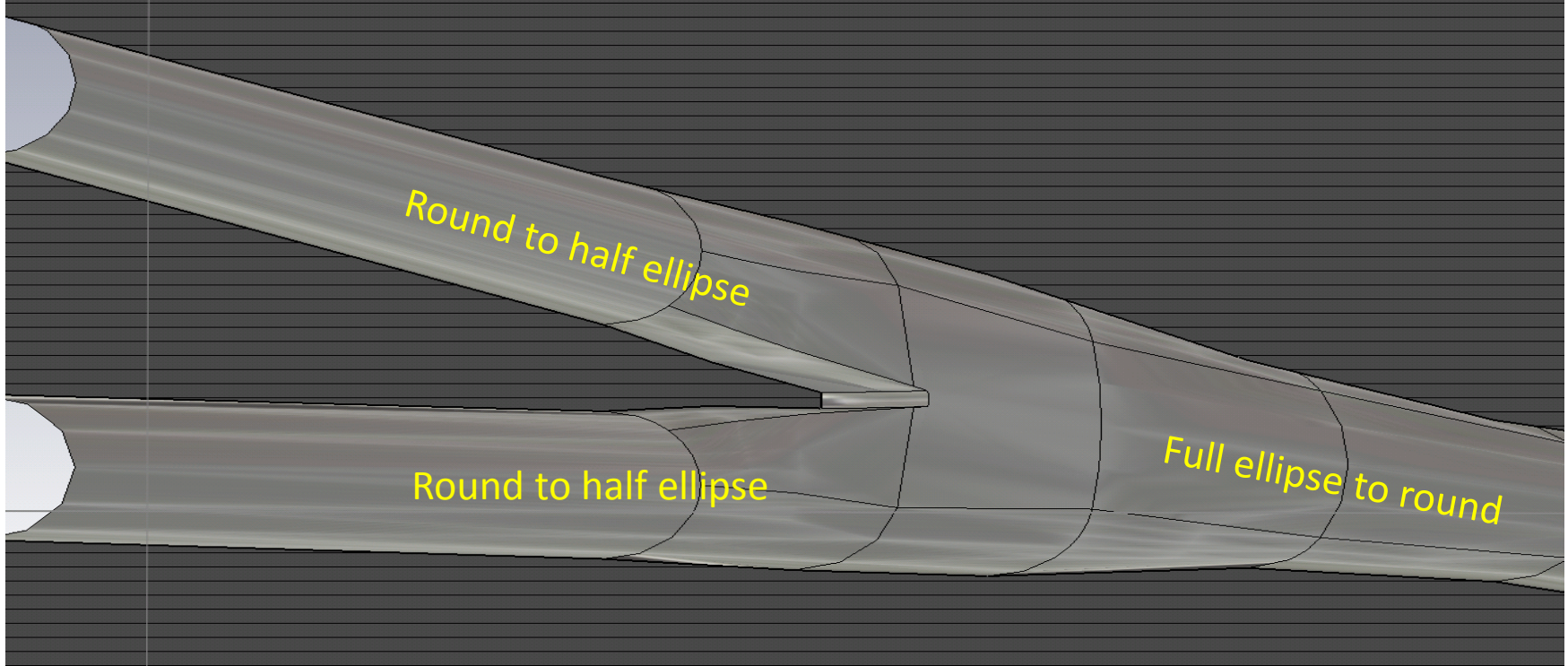
Outline

- I. Geometry of the FCC ee IR beam pipe.
- II. Trapped modes and propagating waves.
- III. HOM absorber.
- IV. Discussion on the resistive-wall wake field losses

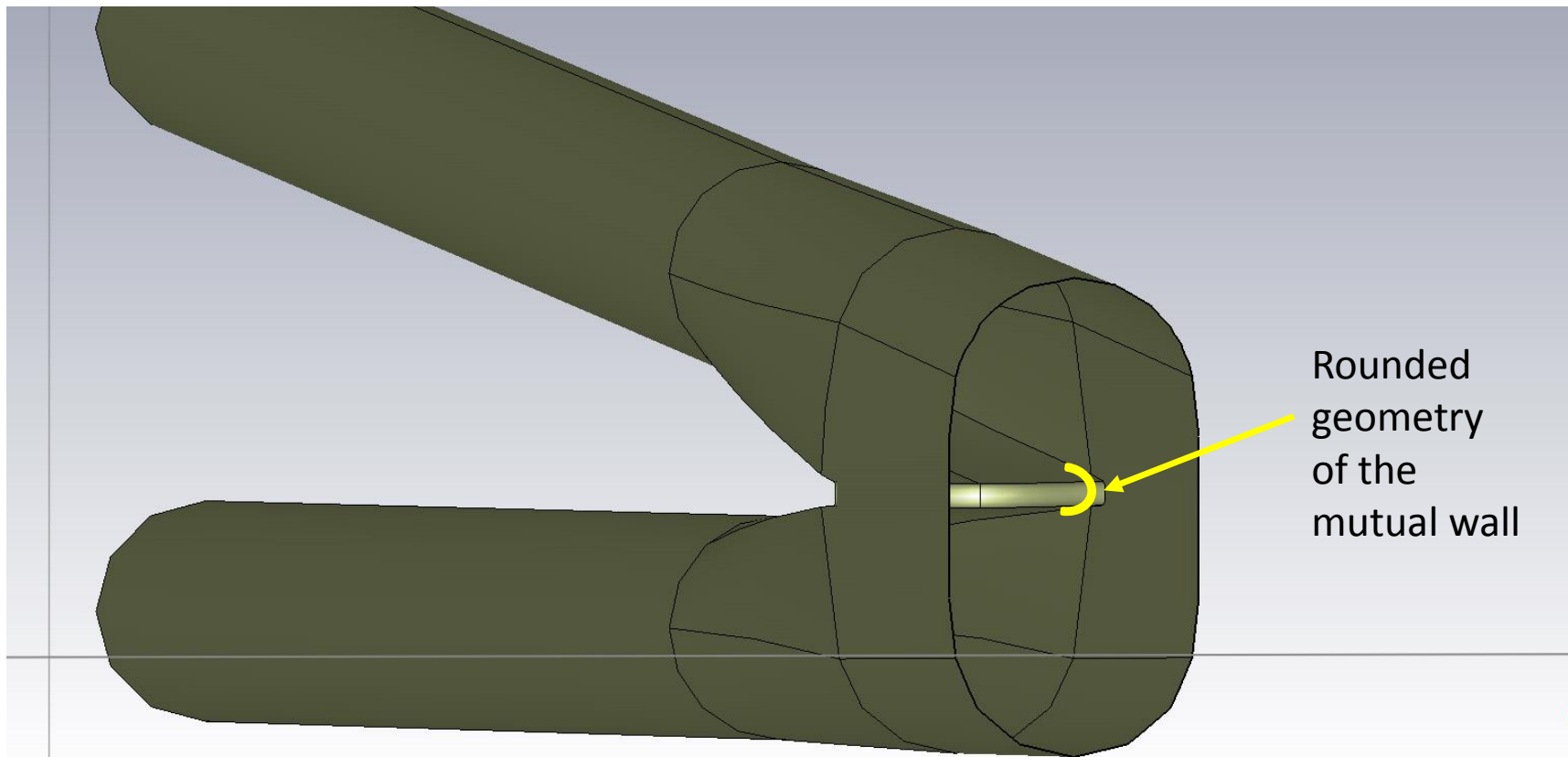
FCC IR beam pipe geometry



All smooth geometrical transitions.



Inner view



Spectrum and cumulative spectral density of the energy losses

PHYSICAL REVIEW ACCELERATORS AND BEAMS 20, 111005 (2017)

Unavoidable trapped mode in the interaction region of colliding beams

Alexander Novokhatski* and Michael Sullivan

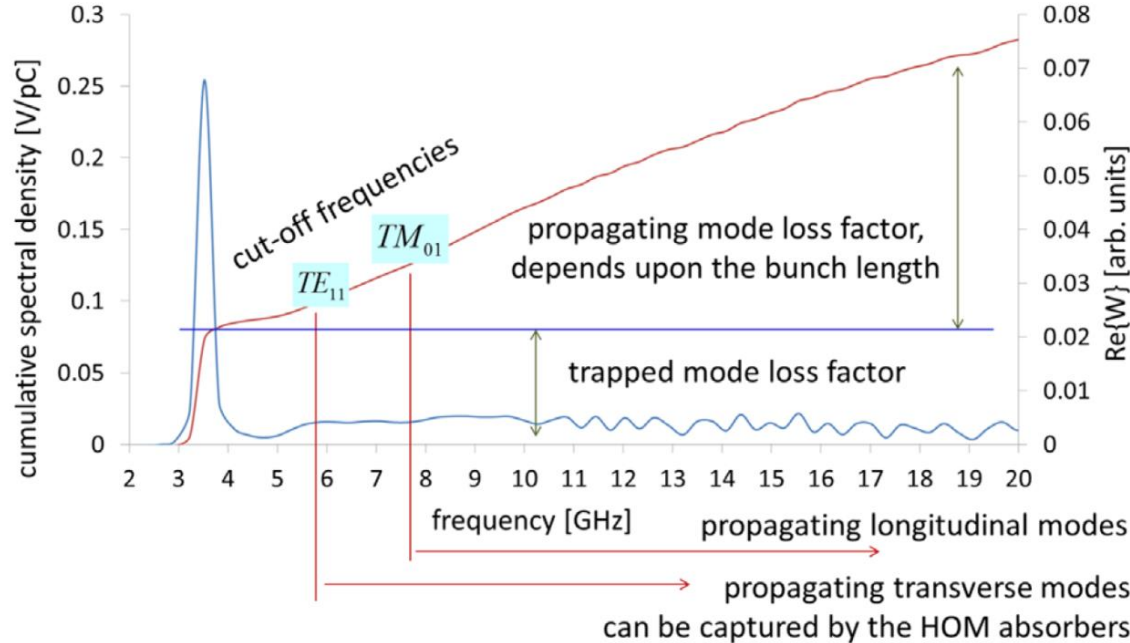
SLAC National Accelerator Laboratory, Menlo Park, California 94025, USA

Eleonora Belli, Miguel Gil Costa, and Roberto Kersevan

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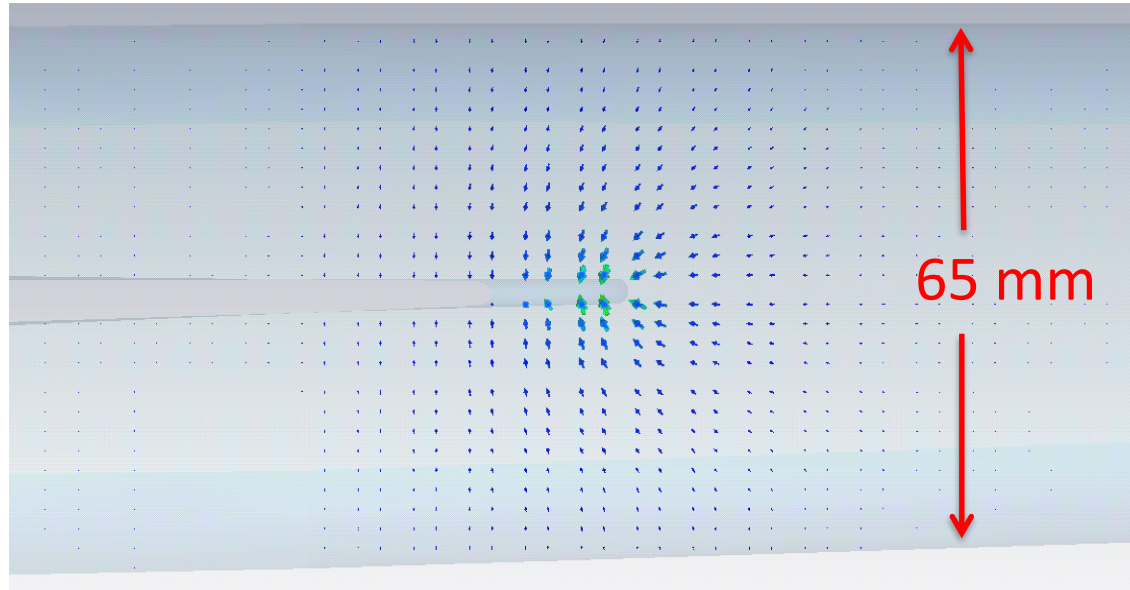
$$P_{prop} = I^2 (k - k_{HOM}) \times \tau_b$$

$$P_{HOM} = 2I^2 k_{HOM} \tau_{l,HOM}$$



Because of the very high bunch charge $Q \sim 30$ nC and high current $I \sim 1.4$ A, each beam will produce electromagnetic power of approximately 5 KW in both beam pipe connections.

A trapped HOM in IR



A trapped mode is localized in the region where two beam pipes emerge into one. This mode has a transverse electrical component near the pipe connection. If we make longitudinal cuts here in the wall then this mode will radiate out of the beam pipe.

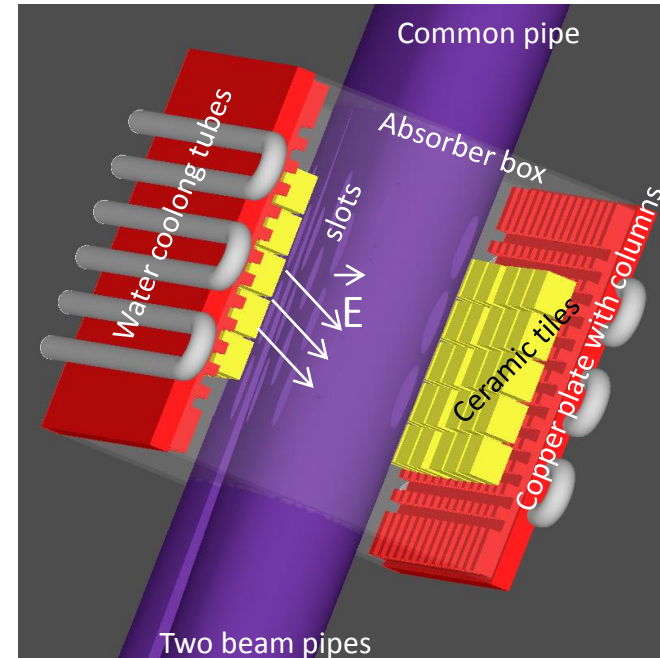
The concept of the HOM absorber

The absorber vacuum box is situated near (around) beam pipe connection. Inside the box we have ceramic absorbing tiles and copper plates (walls). The beam pipe in this place have longitudinal slots, which connect the beam pipe and the absorber box. Outside the box we have stainless steel water-cooling tubes, braised to the copper plates.

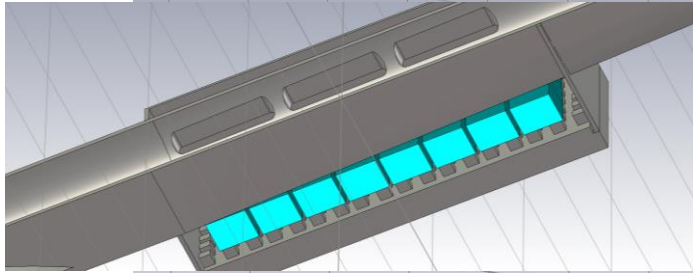
HOM fields, which are generating by the beam in the IR have a transverse electrical component and can pass through the longitudinal slots in the beam pipe.

Inside the absorber box these fields are absorbed by ceramic tiles, which have high value of the loss tangent.

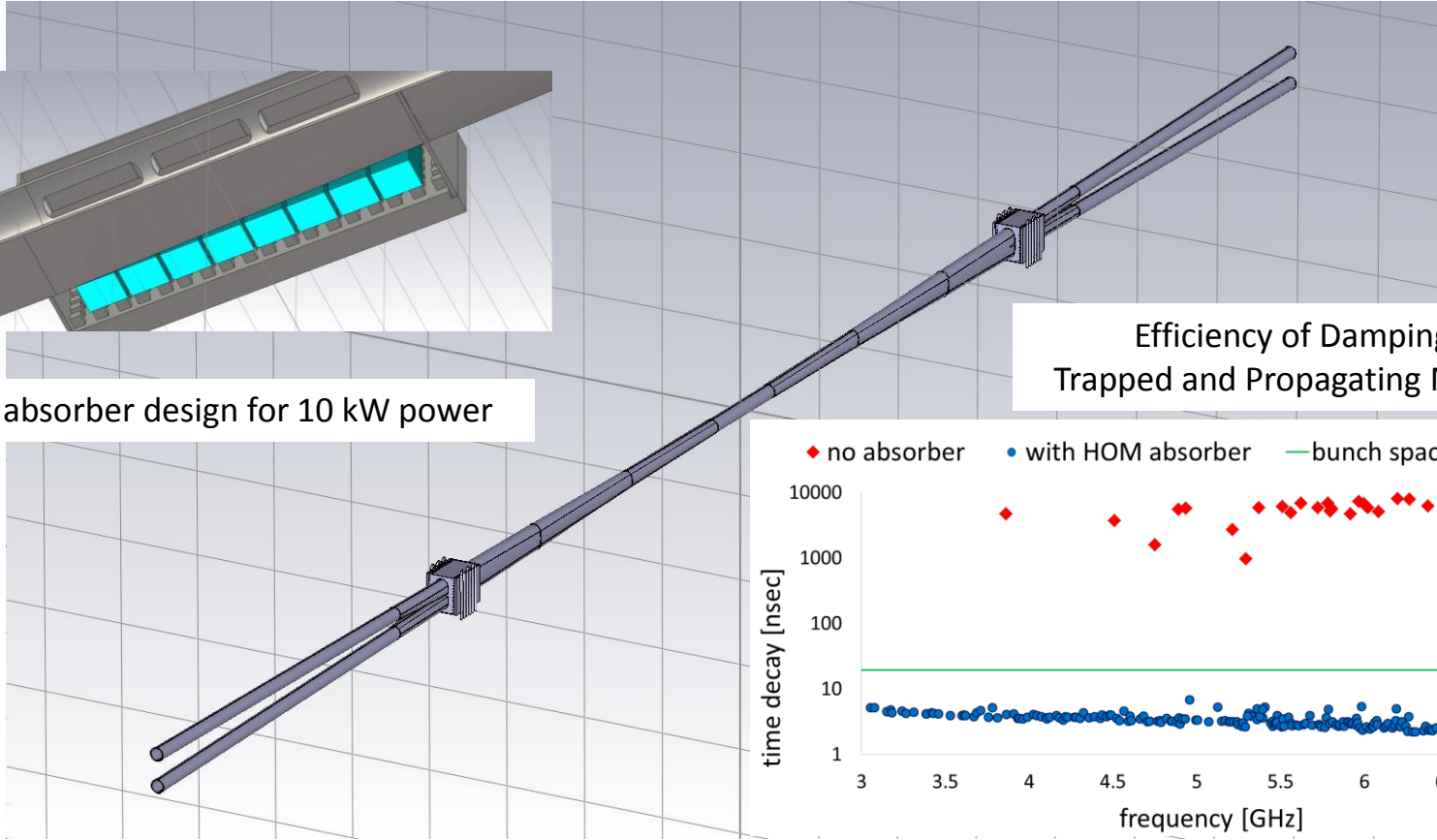
Ceramic tiles are braised to copper plates with columns. The heat from ceramic tiles is transported through the copper plates to water cooling tubes.



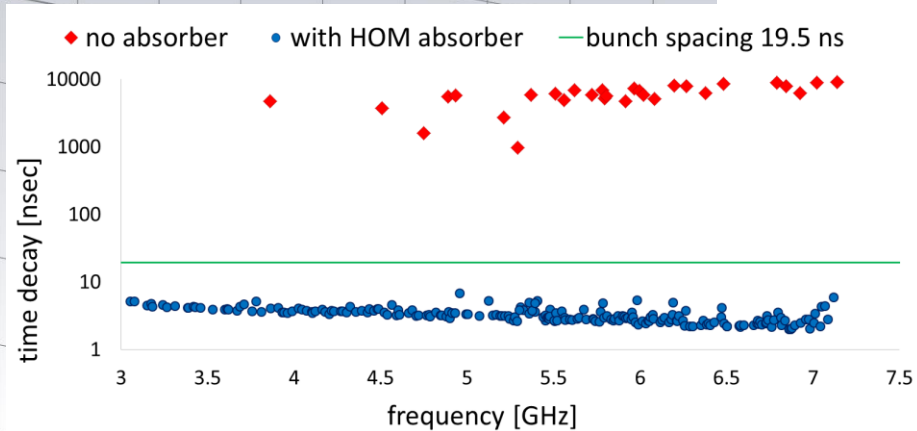
FCC ee IR beam pipe with water-cooled HOM absorbers



HOM absorber design for 10 kW power



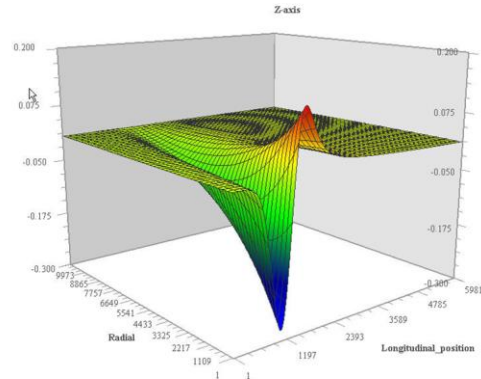
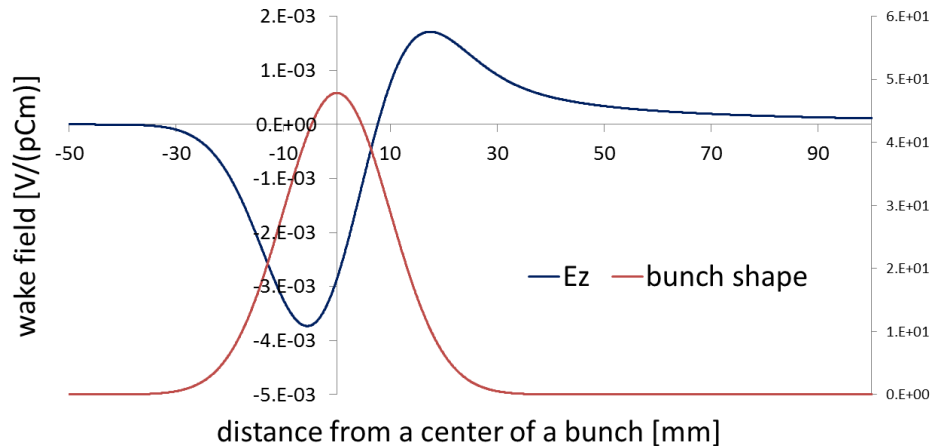
Efficiency of Damping Trapped and Propagating Modes



Other main source for the IR heat load

- Other electromagnetic fields exciting by the beams in the Interaction Region are due to the finite conductivity of the metal walls of the IR beam pipe

10 mm bunch
in the Be
30 mm pipe



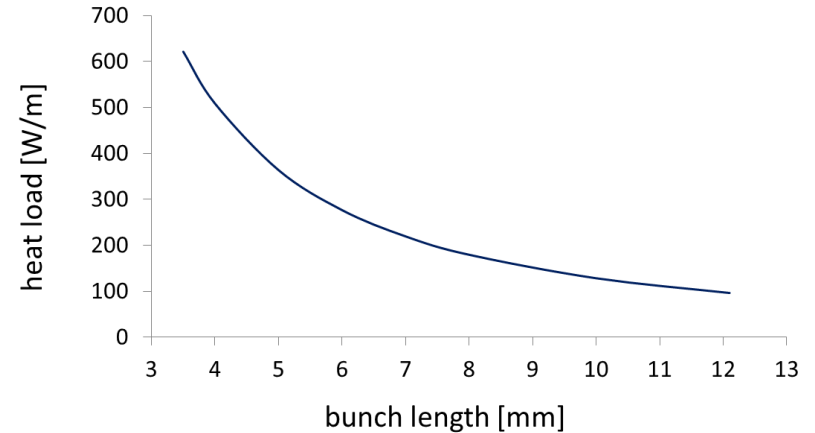
- Electrical conductivity of different materials, which can be used in IR:

Material	Cu	Au	Al	Be	Ni	SS	NEG
conductivity [Ohm/mm]	58000	48800	35000	25000	14600	1400	50 -->1000

Heat load.

bunch length [mm]	HEAT LOAD Two beams [W/m]				current [A]	Bunch spacing [ns]	
					2 x 1.39	19.50	
12.10	63.45	69.18	81.68	96.57	125.23	349.64	1473.91
Material	Cu	Au	Al	Be	Ni	SS	NEG

- Beryllium pipe takes 100 W/m for a 12 mm bunch but strongly increasing with shortening the bunch length.



Properties of Pure Beryllium

- The principal properties of beryllium are its low density, high strength, high rigidity, reflectivity, structural stability at high temperatures and conductivity of heat. Beryllium is notable among metals in terms of specific rigidity; i.e. the ratio of modulus to density.

	Beryllium	Aluminium 7075-T6	Titanium 6Al-4v	Steel 4340	Magnesium AZ80A	Metal-Matrix Composite
Density	1.85	2.80	4.43	7.83	1.80	2.91
g/cm ³	0.067	0.101	0.16	0.28	0.065	0.105
lb/ins						
Tensile Modulus	303	72	113	203	44	131
GPa	44	10.4	16.5	29.5	6.4	19
10 ⁶ psi						
Thermal Expansion	11	23	10	15	26	14
Coefficient	6.3	13	5.5	8.3	14	7.6
ppm/K						
ppm/F						
Specific Heat	1925	920	540	500	1000	800
J/kg.K	0.46	0.22	0.13	0.12	0.24	0.19
BTU/lb.F						
Thermal Conductivity	182	215	4	47	52	12
W/m.K	1056	125		27	0.30	72
BTU/ft.hr.F						

No cooling Be pipe. Rough estimate.

$$DT_{[K^\circ]} = \frac{P_{[W]} * L_{[m]}}{k_{[W/(K^\circ m)]} * 2\rho R_{[m]} Dr_{[m]}}$$

power	length	conductivity	Radius	thickness	dT
[W/m]	[m]	[W/(m k)]	[m]	[m]	[K]
100.000	0.125	182.000	0.015	0.001	91.091
200.000	0.125	182.000	0.015	0.001	182.183

Summary

- HOM absorber is needed
- Water cooling or other cooling is needed for IP beam pipe.
- Waiting for a new cad file with more details of IP chamber.